





SURFACE MOUNT SCHOTTKY BARRIER DIODE

Product Summary (@TA = +25°C)

V _{RRM} (V)	I _O (mA)	V _{F(MAX)} (V)	I _{R(MAX)} (μA)
30	200	1	2.0

Features and Benefits

- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Leadless Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The BAT54LPQ is suitable for automotive applications requiring specific change control; it is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Applications

- SMPS
- Free Wheeling Diodes
- Reverse Polarity Protection
- DC-DC Converters
- General Switching Applications

Mechanical Data

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Finish NiPdAu Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 @
- Weight: 0.001 grams (Approximate)

X1-DFN1006-2





Top View

Bottom View

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
BAT54LPQ-7	Automotive	X1-DFN1006-2	3000/Tape & Reel
BAT54LPQ-7B	Automotive	X1-DFN1006-2	10,000/Tape & Reel

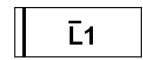
Notes:

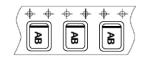
- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Top View





Top View

Bar Denotes Cathode Side

L1 or $\overline{L}1$ = Product Type Marking Code Bar Denotes Cathode Side



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage		V_{RRM}		
Working Peak Reverse Voltage		V_{RWM}	30	V
DC Blocking Voltage		V_{R}		
Average Rectified Output Current		lo	200	mA
Repetitive Peak Forward Current		I _{FRM}	300	mA
Forward Surge Current	@ t < 1.0s	I _{FSM}	600	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_D	250	mW
Thermal Resistance, Junction to Ambient Air (Note 5)	$R_{ hetaJA}$	400	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +125	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

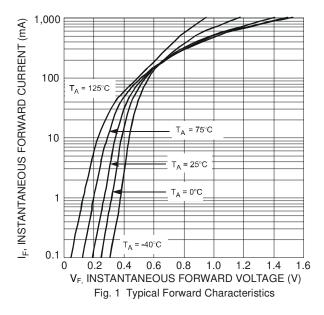
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	30	_	_	V	$I_R = 100\mu A$
		_	_	240		I _F = 0.1mA
				320		I _F = 1mA
Forward Voltage	V _F			400		I _F = 10mA
				500		I _F = 30mA
				1,000		I _F = 100mA
Reverse Leakage Current (Note 6)	I _R	_	_	2.0	μΑ	V _R = 25V
Total Capacitance	C _T		_	10	pF	$V_R = 1.0V, f = 1.0MHz$
Reverse Recovery Time	t _{RR}		_	5.0	ns	I_F = 10mA through I_R = 10mA to I_R = 1.0mA, R_L = 100 Ω

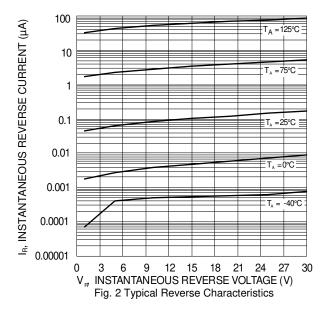
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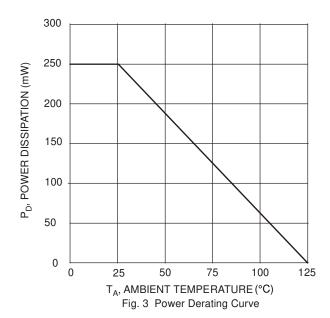
^{5.} Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

^{6.} Short duration pulse test used to minimize self-heating effect.







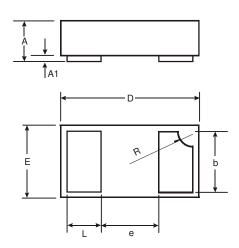




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-2

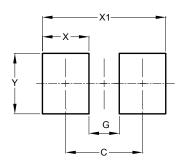


X1-DFN1006-2				
Dim	Min	Max	Тур	
Α	0.47	0.53	0.50	
A 1	0	0.05	0.03	
b	0.45	0.55	0.50	
D	0.95	1.075	1.00	
Е	0.55	0.675	0.60	
е	-	-	0.40	
L	0.20	0.30	0.25	
R	0.05	0.15	0.10	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-2



Dimensions	Value		
Difficusions	(in mm)		
C	0.70		
G	0.30		
Х	0.40		
X1	1.10		
Υ	0.70		



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